



Dynatron G17 3U Server & Up CPU Heatsink - Socket LGA 1366

\$38.99

Product Images



Short Description

Product Details:

Dynatron G17 CPU Cooler for socket 1366, Workstation & Tower Desktop Solution



Intelligent
H.C.C.



Low
Noise



High-density
wave-fin



U-Shape
Heatpipe X4



Energy-Saving
PWM



RoHS

Specifications:

CPU Socket 1366

CPU Support Intel® Xeon® Processor 5000 Series & Xeon® Processor W3690, W3680, W3670, W3580, W3570, W3565, W3550, W3540, W3530, W3520

Solution 3U&Up, Workstation & Tower Desktop Solution

Overall Dimension 91.0 x 91.0 x 110.0 mm

Weight 530 g

Material Aluminum Fins, 4x Heat Pipes with H.C.C. Technology

Fan Dimension Ø92 x 25 mm

Speed At Duty Cycle 20%: 1000 RPM
At Duty Cycle 50%: 1800 RPM
At Duty Cycle 100%: 2500 RPM

Bearing 2 Ball Bearing

Rated Voltage 12 V

Power At Duty Cycle 20%: 0.96 W
At Duty Cycle 50%: 1.44 W
At Duty Cycle 100%: 3.0 W

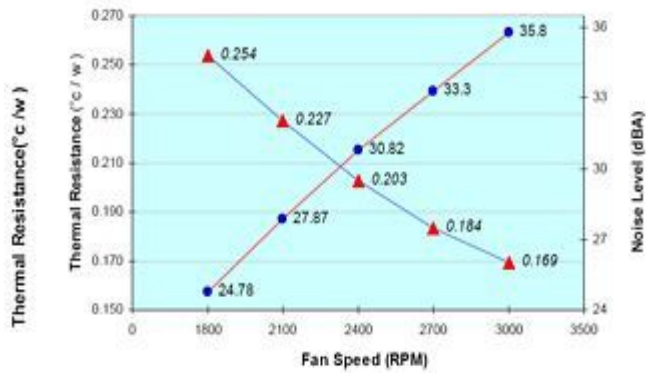
Air Flow At Duty Cycle 20%: 17.34 CFM
At Duty Cycle 50%: 31.21 CFM
At Duty Cycle 100%: 43.36 CFM

Noise Level At Duty Cycle 20%: 17.0 dBA
At Duty Cycle 50%: 24.78 dBA
At Duty Cycle 100%: 31.92 dBA

Air Pressure At Duty Cycle 20%: 0.48 mm-H2O
At Duty Cycle 50%: 1.55 mm-H2O
At Duty Cycle 100%: 3.0 mm-H2O

Lead Wire Pin Out
 Pin1- (-)
 Pin2- (+)
 Pin3- (Techometer/Signal output)
 Pin4- (PWM)

Cooling Performance VS. Airflow (Wind Tunnel Simulation)



- Note
1. Support CPU Power up to 140 Watts Overclocking
 2. Pre-print thermal compound Shin-Etsu G751
 3. RoHS Compliance
 4. Backplate is not included

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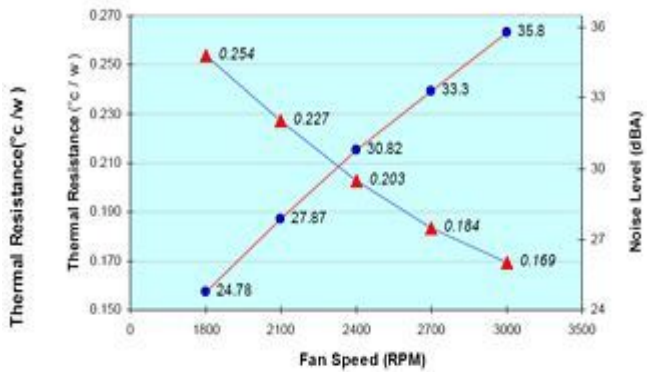
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Additional Information

Brand	Dynatron
SKU	G17-D
Weight	2.0000
Compatibility	Intel LGA 1366
Material	Copper/Aluminum

